Version: 1.1

CHT-PLUTO-B1220
Preliminary Datasheet
High Temperature 1200V/20A Dual SiC MOSFET Module

General description

CHT-PLUTO-B1220 is a high temperature 1200V/20A Dual Silicon Carbide MOSFET in a single hermetic module. It is suitable to implement a power half bridge for applications such as DC-DC converters or motor drives in high temperature environments. The two independent switches can be used in parallel to deliver a total of 40A. This product is guaranteed for normal operation on the full range -55°C to +210°C (Tj). Each MOSFET has a breakdown voltage in excess of 1200V and is capable of switching current up to 20A. They have a on-resistance of 90mΩ at 25°C and 200mΩ at 210°C at VGS=20V. Each MOSFET has an intrinsic body diode.

Benefits

- High power density converters (support of high-frequency switching and reduced cooling)
- Extended lifetime and high reliability
- Harsh environments and high temperature power converters
- Seamless driving with HADES® gate driver solutions

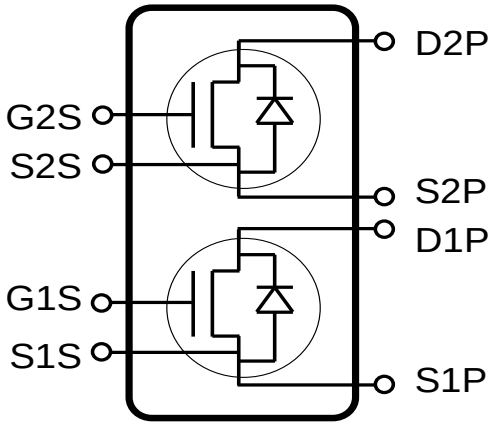
Applications

- DC motor drives and actuator control
- DC-DC converters

Features (per switch)

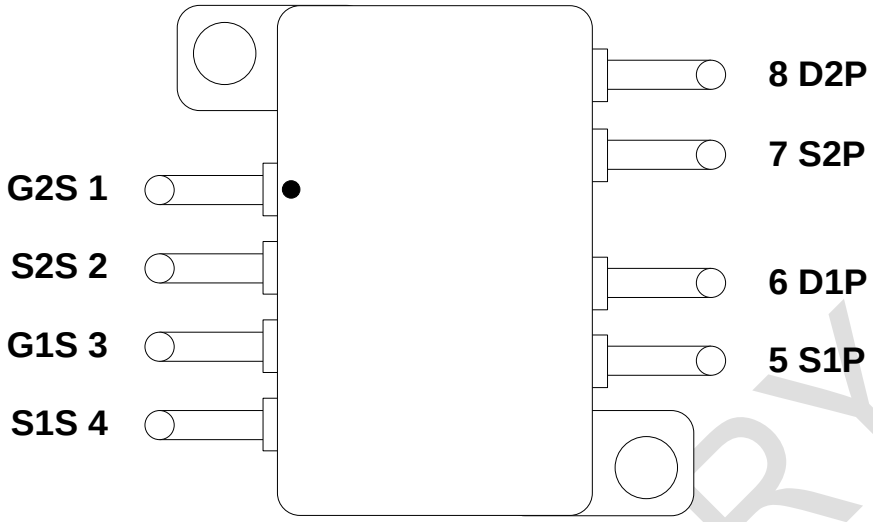
- Specified from -55 to +210°C (Tj)
- V_{DS} Max: 1200V
- Max Continuous Current:
  - 20A @ Tc≤160°C
  - 17A @ Tc=175°C
- Max Pulsed Current: 25A
- Typical On-resistance:
  - R_{DSon}= 40 mΩ @ Tj=25°C
  - R_{DSon}= 120 mΩ @ Tj=210°C
- High Speed Switching
- Voltage control: V_{GS}=-5V/20V
- Low gate charge: Q_{GS}: 22nC
- Hermetic package with isolated case

Functional Block Diagram



Note: the schematic shows the intrinsic body diode

Package configuration and Pin Description



Pin ID	Pin Name	Pin Description	Pin Finish
1	G2S	Gate of MOSFET 2 (Signal Pin)	Nickel
2	S2S	Source of MOSFET 2 (Signal Pin)	Nickel
3	G1S	Gate of MOSFET 1 (Signal Pin)	Nickel
4	S1S	Source of MOSFET 1 (Signal Pin)	Nickel
5	S1P	Source of MOSFET 1 (Power Pin)	Nickel
6	D1P	Drain of MOSFET 1 (Power Pin)	Gold
7	S2P	Source of MOSFET 2 (Power Pin)	Nickel
8	D2P	Drain of MOSFET 2 (Power Pin)	Gold
	Body	Package body (isolated from Pins)	Nickel

Absolute Maximum Ratings

Gate-to-Source voltage V_{GS}	-5V to 22V
Drain-to-Source voltage V_{DS}	1200V
Max DC Drain current I_{DS}	20A
Max Junction temperature T_{jmax}	210°C
Power dissipation at Tc=175°C (*)	45W

ESD Rating

Human Body Model	>1kV

Operating Conditions (per switch)

Gate-to-Source voltage V_{GS}	-5V to 20V
Drain-to-Source voltage V_{DS}	1200V
Max DC drain current I_{DS} (Tc=175°C)	17A
Max DC drain current I_{DS} (Tc≤160°C)	20A
Max pulsed drain current	25A
Junction temperature	-55°C to +210°C

(*): per switch position and including switching losses

Electrical characteristics (per switch)

Unless otherwise stated, T_j =25°C. **Bold** figures point out values valid over the whole temperature range (T_j =-55°C to +210°C).

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Threshold voltage	V_{TH}	T_j=25°C ; I_D = 1mA; V_{DS} = 20V		4.45		V
		T_j=210°C ; I_D = 1mA; V_{DS} = 20V		3.28		V
Drain cut-off current	I_{DSS}	V_{GS} =0V, V_{DS}=1200V, T_j=25°C		20		nA
		V_{GS} =0V, V_{DS} =1200V, T_j=210°C		10		µA
Gate leakage current	I_{GSS}	V_{GS} =20V, V_{DS} =1200V, T_j=25°C		5		nA
		V_{GS} =20V, V_{DS} =1200V,T_j=210°C		20		nA
Static drain-to-source resistance	R_{DSon}	V_{GS} =20V, ID=20A, T_j=25°C		40		mΩ
		V_{GS} =20V, ID=20A, T_j=210°C		120		mΩ
Breakdown drain-to-source voltage (DC characterization)	V_{BRDS}	V_{GS} =0V; ID = 1 mA	**1200**			V
Input capacitance	C_{ISS}	V_{GS} =0V_{DC}, V_{DS} =600V f = 1 MHz V_{AC} = 25mV		1337		pF
Output capacitance (includes diode capacitance)	C_{OSS}			76		pF
Feedback capacitance	C_{RSS}			27		pF
Turn-on delay time	$T_{d(ON)}$	VDD=600V; VGS= -4/20V ID = 20A RG= 6.8Ω; L = 856µH		21		ns
Fall time	T_r			39		ns
Turn-off delay time	$T_{d(OFF)}$			49		ns
Rise time	T_f			24		ns
Turn-On Switching Loss	E_{on}			240		µJ
Turn-Off Switching Loss	E_{off}			140		µJ
Internal gate resistance	R_G	V_{GS} =0$V_{DC;}$ f = 1 MHz; V_{AC} = 25mV		7		Ω
Gate to Source Charge	Q_{GS}	Tj=25°C ;VDD= 800V; ID = 20A; VGS = -4/20V		22		nC
Gate to Drain Charge	Q_{GD}			41		nC
Total Gate Charge	Q_G			107		nC
Diode forward voltage	V_F	Tj=25°C; IF=20A; V_{GS}=-5V		3.6		V
		Tj=210°C; IF=20A; V_{GS}=-5V		3.2		V
Reverse recovery time	T_{rr}	Tj=25°C; V_{DS}=300V; V_{GS} = -5V; I_F=20A;dI_F/dt = 100A/µS		220		ns
Peak reverse recovery current	I_{prr}			2.3		A

Thermal Characteristics

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Junction-to-Case Thermal resistance MOSFET	$R_{\Theta JC}$			1.1		°C/W

Typical performances (per switch)

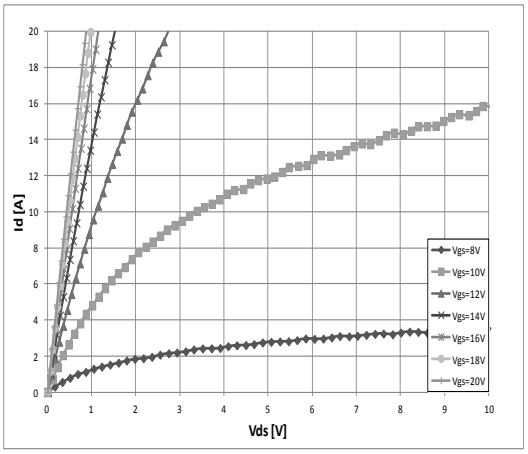


Figure 1: Drain current vs V_{DS} (T_j= 25°C)

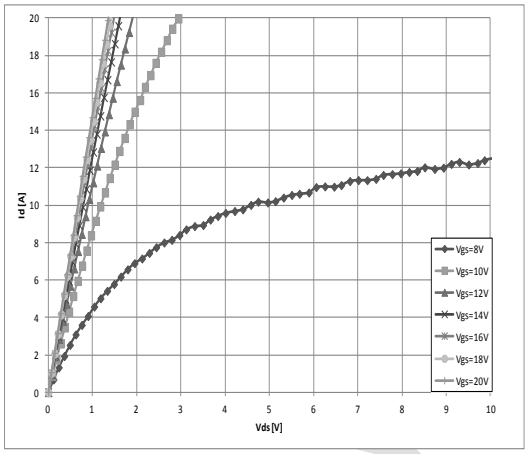


Figure 2: Drain current vs V_{DS} (T_j= 125°C)

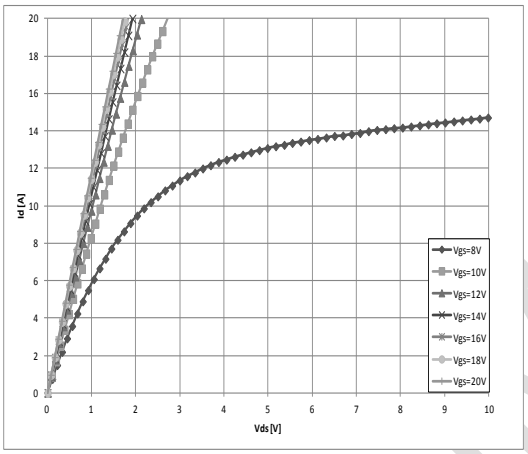


Figure 3: Drain current vs V_{DS} (T_j= 175°C)

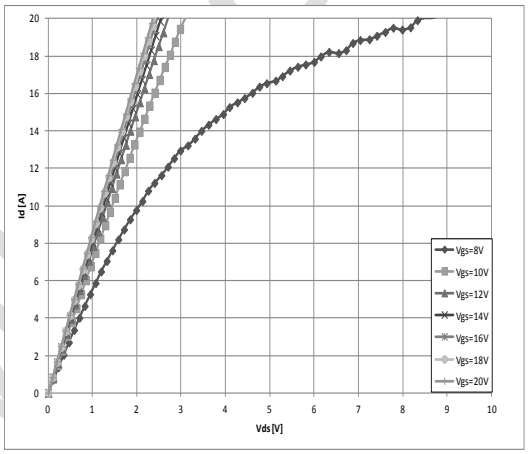


Figure 4: Drain current vs VDS (Tj= 210°C)

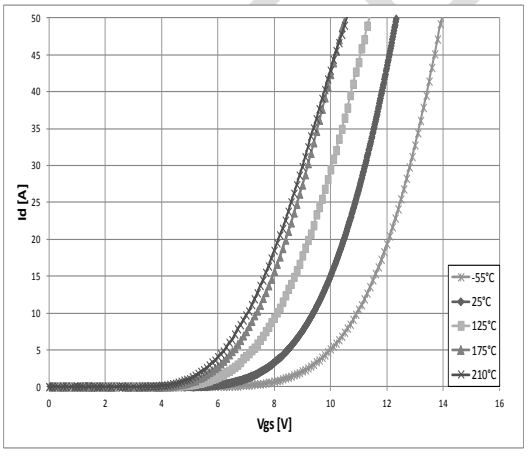


Figure 5: Drain current vs V_{GS} voltage

Typical performances (cnt'd)

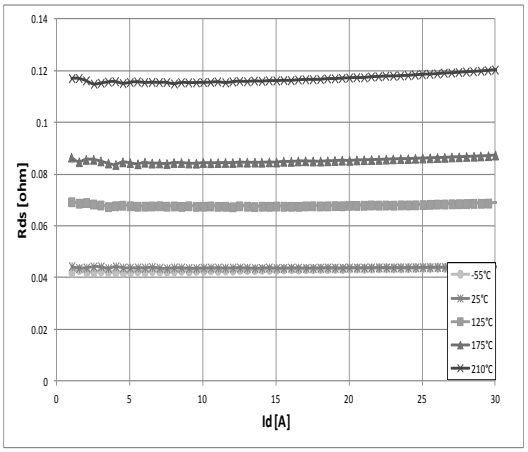


Figure 6: On-state drain source resistance vs. Drain current (V_{GS} =20V)

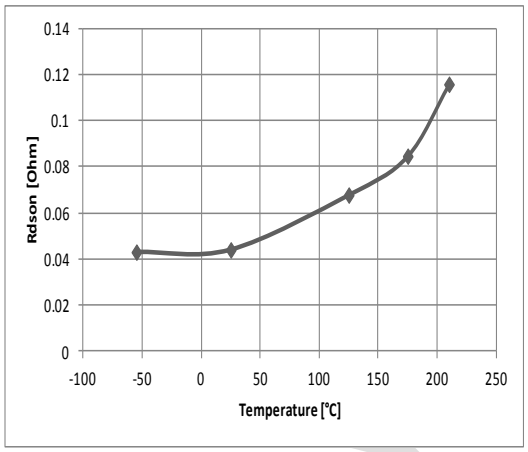


Figure 7: On-state drain source resistance vs. Temperature (V_{GS} =20V; I_{DS}=10A)

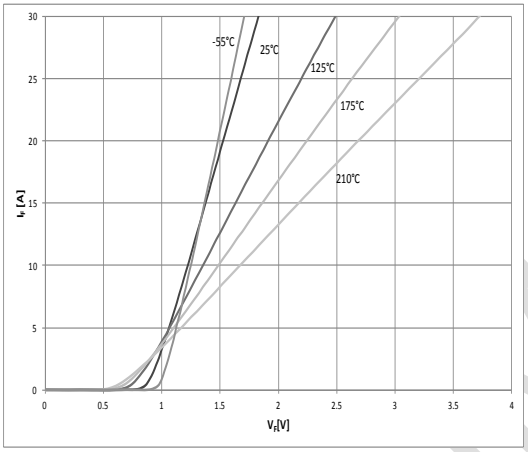
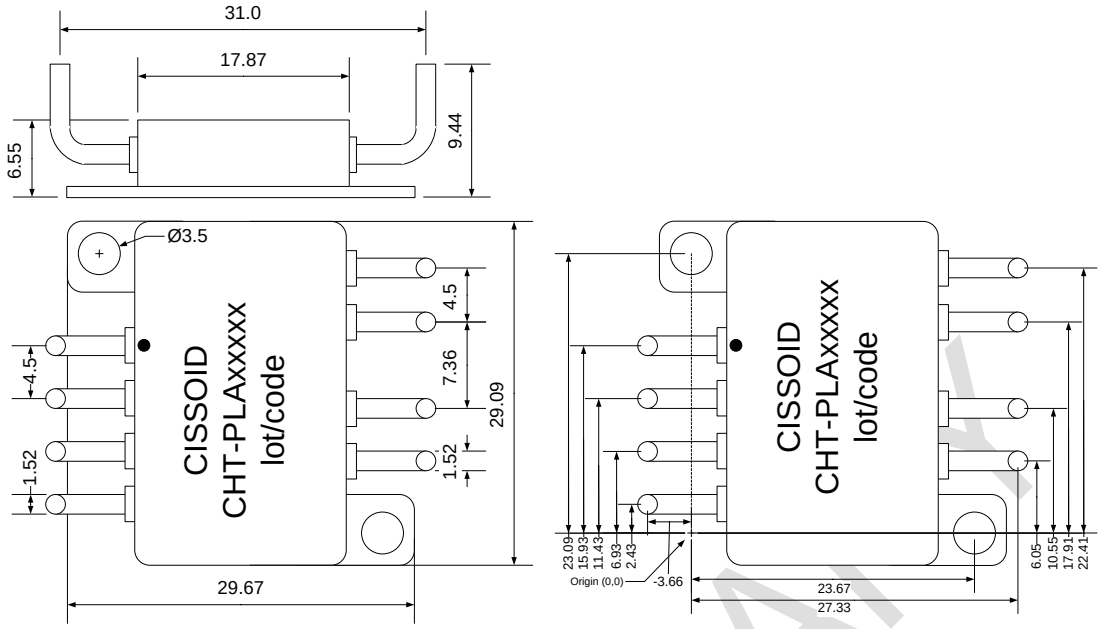


Figure 8: Diode I_{DS} vs V_{DS} (3^{rd} quadrant;VGS=-5V)

Package Dimensions



HM8A dimensions in mm (+/- 10%)

Ordering Information

Product Name	Ordering Reference	Package	Marking
CHT-PLUTO-B1220	CHT-PLA8294A-HM8A-T	HM8A	CHT-PLA8294A

Related products

Product Name	Function	Ordering Reference
CHT-PLUTO-B1230	Dual 1200V/30A SiC MOSFET Module	CHT-PLA2316A-HM8A-T
CHT-PLUTO-C1230	1200V/30A SiC Async Buck or Boost Power Module	CHT-PLA2228A-HM8A-T
CHT-PLUTO-C1220	1200V/20A SiC Async Buck or Boost Power Module	CHT-PLA3777A-HM8A-T

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